

HVD138

Silicon Epitaxial Trench Pin Diode for Antenna Switching

HITACHI

ADE-208-958 (Z)

Rev.0

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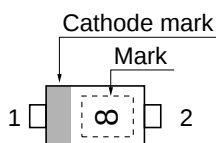
Features

- Adopting the trench structure improves low capacitance. ($C = 0.9 \text{ pF max}$)
- Low forward resistance. ($r_f = 0.8 \Omega \text{ max}$)
- Low operation current.
- Super small Flat Package (SFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVD138	8	SFP

Outline



1. Cathode
2. Anode

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	30	V
Forward current	I_F	100	mA
Power dissipation	P_d	150	mW
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_R	—	—	10	nA	$V_R = 25\text{ V}$
Forward voltage	V_F	—	—	0.9	V	$I_F = 2\text{ mA}$
Capacitance	C	—	—	0.9	pF	$V_R = 1\text{ V}$, $f = 1\text{ MHz}$
Forward resistance	r_f	—	—	0.8	Ω	$I_F = 2\text{ mA}$, $f = 100\text{ MHz}$

Note: 1. Please do not use the soldering iron due to avoid high stress to the SFP package.

Main Characteristic

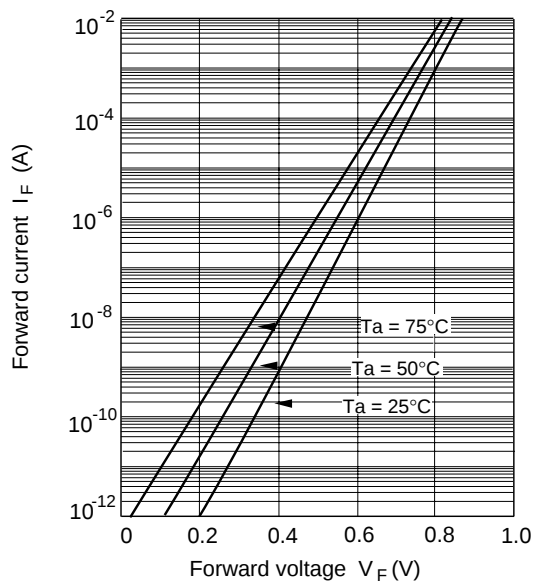


Fig.1 Forward current Vs. Forward voltage

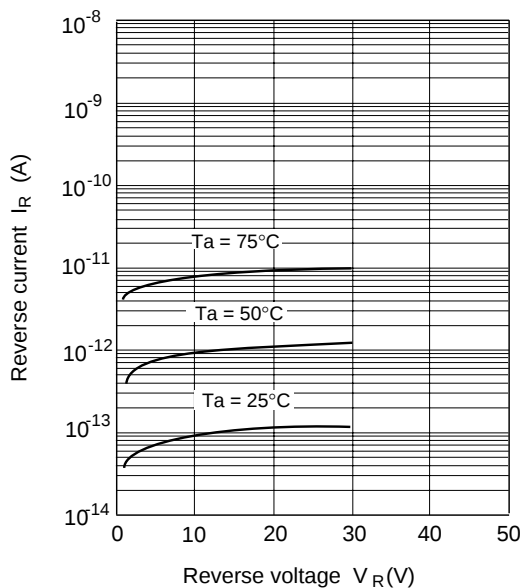


Fig.2 Reverse current Vs. Reverse voltage

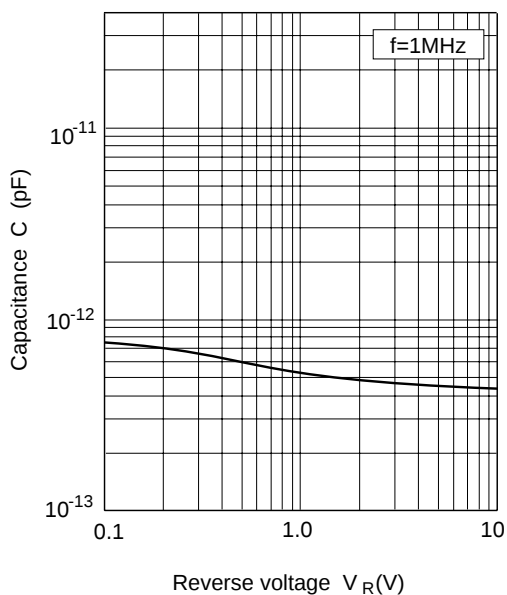


Fig.3 Capacitance Vs. Reverse voltage

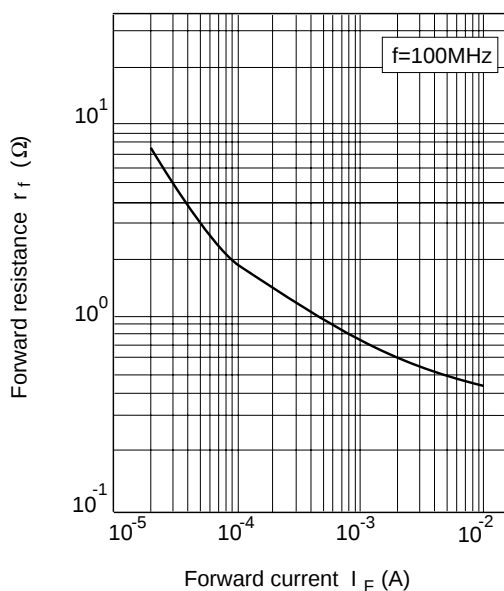


Fig.4 Forward resistance Vs. Forward current

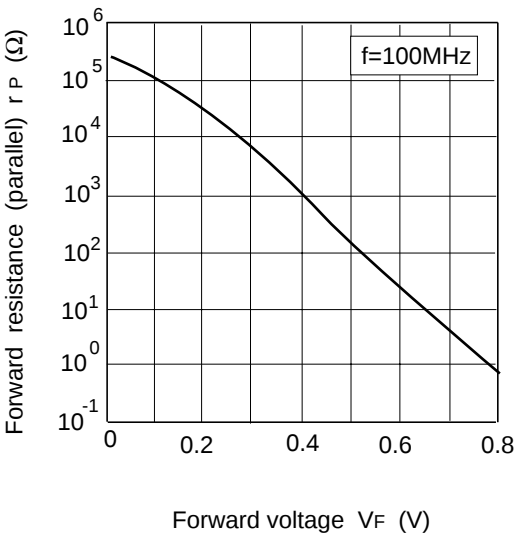
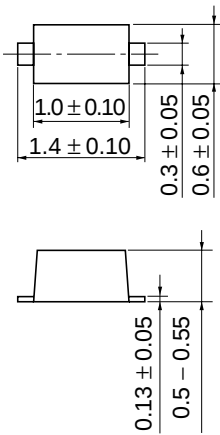


Fig.5 Forward resistance (parallel) Vs. Forward voltage

Package Dimensions

Unit: mm



Hitachi Code	SFP
JEDEC	—
EIAJ	—
Mass (reference value)	0.0010 g

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